

» ETX®-LX «



ETX® 3.0
Long Term Support

ETX® 3.0 – setting the standard again!

- » AMD Geode™ LX800 and CS5536
- » Lowest power consumption
- » DDR SODIMM for maximum memory throughput
- » ETX® 3.0 Long Term Support
- » 2x SATA, 4x USB 2.0, Graphics, CompactFlash™, etc.

ETX®-LX

ETX® 3.0 - setting the standard again!

The ETX®-LX (Embedded Technology eXtended) is a highly integrated and fast Computer-on-Module with extreme low power consumption. It allows, due to the used AMD LX800 processor, the usage of the board without active cooling in applications, where space limitations (the maximum height without heat sink is only 10 mm!) are major requirements. It also takes advantage of the new ETX 3.0 specification that allow for 2

Serial ATA ports without violating the existing ETX 2.8 pin usage.

A CompactFlash™ socket is already mounted on the ETX®-LX and offers you a lot of possibilities. For further expansions two PATA ports with UDMA66 capabilities are available. They do not provide the PCI bus only, the ISA bus signals are also available. A lot of existing ISA boards can still be used via an ISA slot on a baseboard. This avoids expensive redesigns and well proven ISA cards to PCI versions for standard PC motherboards.

Technical Information

Processor Cache Chipset Memory **Hard Disk** Ethernet Sound Video Controller **LVDS and CRT Resolutions** Other Features Form Factor **Power Consumption** Form Factor Temperature (*) Humidity

Storage: -30°C to 85°C

AMD Geode™ LX800 processor 500MHz, with integrated graphic 128 KB L2 Cache

AMD Geode™ CS5536 Companion Device Up to 1 GB DDR-RAM (266/333/400)

2x SerialATA (RAID 0, 1), 1x PATA 100, 1x CompactFlash™ socket on board

10/100 MBit Ethernet, Intel® 82551ER

ALC203 AC97 controller, line-input / output and microphone

Integrated in Geode™ LX800, up to 254 MB UMA

LVDS up to UXGA (1600x1200), CRT up to WUXGA (1920x1440)

Parallel/Floppy port shared with LPT

ETX® 3.0; 95 x 114 x 10 mm Typ. Idle 6.5 W @ 500 MHz, 5V

ETX® 3.0; 95 x 114 x 10 mm Operation: 0°C to 60°C

Operation: 10% to 90%

Storage: 5% to 95% (non condensing)

(*) Ask about extended temperature ranges

Ordering Information

Article ETX®-LX ETX®-LX ETX®-LX HSP - trough

ETX®-LX HSP - threaded DDR-SDRAM-SODIMM 256MB DDR-SDRAM-SODIMM 512MB DDR-SDRAM-SODIMM 1GB

Part No.

18027-0000-50-4 18027-0000-50-5 18027-0000-99-0 18027-0000-99-1 97007-2560-00-0 97007-5120-00-0 97007-1024-00-0

AMD LX800 with 500 MHz, with LVDS and 16 Bit ISA I/O AMD LX800 with 500 MHz, with digital Interface and 16 Bit ISA I/O HSP-LX - Heatspreader for ETX-LX, threaded holes HSP-LX - Heatspreader for ETX-LX, through holes DDR-SDRAM SODIMM PC2700 memory module with 256 Mbyte DDR-SDRAM SODIMM PC2700 memory module with 512 Mbyte DDR-SDRAM SODIMM PC2700 memory module with 1 GByte

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